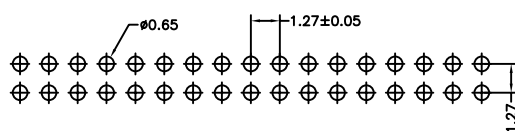
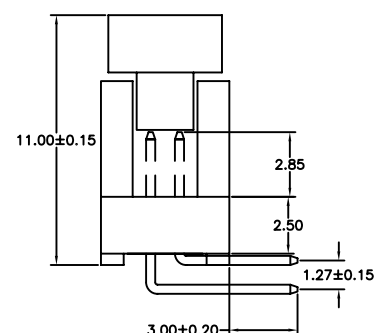
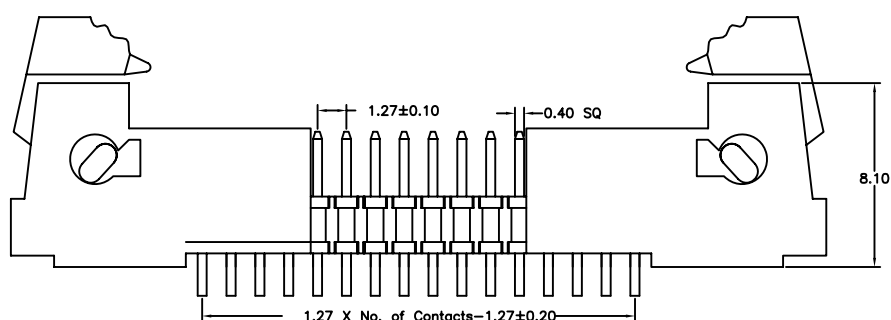
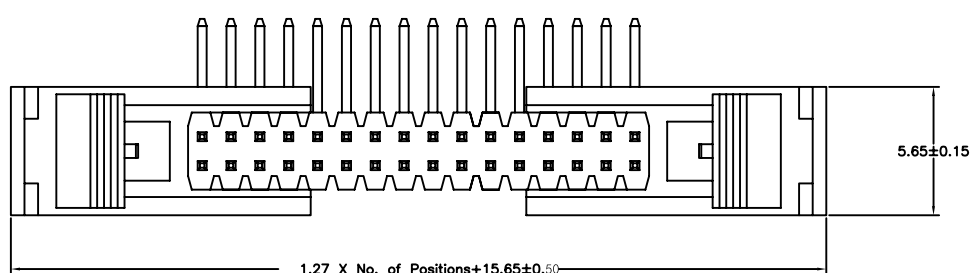


1. 27*1.27mm(0.050"*0.050") EJECTOR HEADER, DUAL ROW, RIGHT ANGLE

SPECIFICATIONS

Current Rating :1AMP
 Contact Resistance :20m Ω Max.
 Insulation Resistance:1000M Ω Min.
 Withstanding Voltage :500V AC/minute
 Operation Temperature:-40 $^{\circ}$ C to+105 $^{\circ}$ C
 Contact Material :Brass
 Contact plating :Gold Flash Plated
 Insulator Material :High Temperature
 Thermoplastic (UL94V-0)
 Standard:PA6T+30%G.F



Recommended PCB Layout

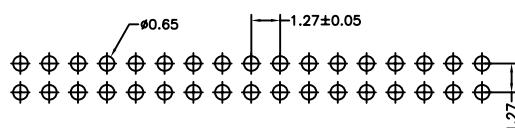
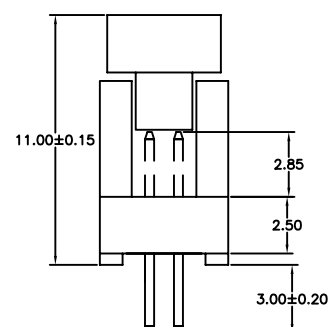
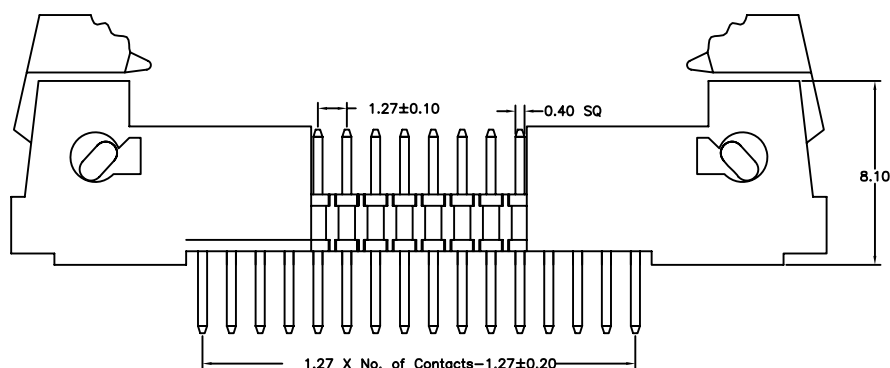
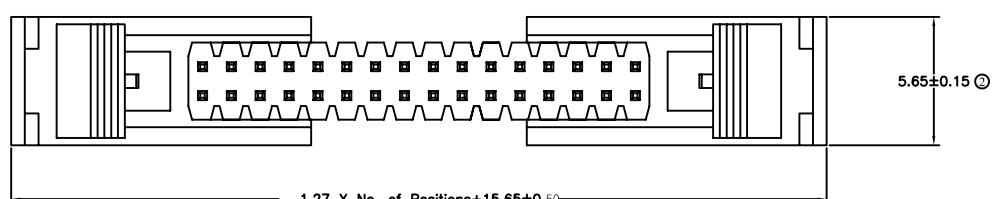
Ordering Information

ECR0811	-	XX	XX	A	XX	B	1	B	X
		No. of total Pins 10~80	Contact Plating 01:Gold Flash 02:Gold 2 μ '' 03:Gold 3 μ '' 04: Tin Duplex Plating 06:Gold Flash/Tin(100 μ '')		Serial Number	Material Type A:PBT B:NYLON 6T C:LCP D:NYLON 9T		Options A:BAG B:TRAY C:TUBE D:TAPE REEL	

1. 27*1.27mm(0.050"*0.050") EJECTOR HEADER, DUAL ROW, DIP TYPE

SPECIFICATIONS

Current Rating :1AMP
 Contact Resistance :20m Ω Max.
 Insulation Resistance:1000M Ω Min.
 Withstanding Voltage :500V AC/minute
 Operation Temperature:-40 $^{\circ}$ C to+105 $^{\circ}$ C
 Contact Material :Brass
 Contact plating :Gold Flash Plated
 Insulator Material :High Temperature
 Thermoplastic (UL94V-0)
 Standard:PA6T+30%G.F



Recommended PCB Layout

Ordering Information

ECS0811	-	XX	XX	A	XX	B	1	B	X
No. of total Pins 10~80		Contact Plating 01:Gold Flash 02:Gold 2 μ '' 03:Gold 3 μ '' 04: Tin Duplex Plating 06:Gold Flash/Tin(100 μ '')		Serial Number		Material Type A:PBT B:NYLON 6T C:LCP D:NYLON 9T			Options A:BAG B:TRAY C:TUBE D:TAPE REEL